

Low-Power Dual 300 mA LDO

Features

- · 2.5V to 5.5V Input Voltage Range
- · Independent Power Inputs
- · Output Voltage Range from 1V to 3.3V
- · Two 300 mA Outputs
- High Output Accuracy (±2%)
- Low Quiescent Current (37 μA Typ. per LDO)
- Stable with 1 µF Ceramic Output Capacitors
- · Low Dropout Voltage (160 mV at 300 mA)
- · Independent Enable Pins
- Internal Enable Pull-Down (MIC5398, MIC5399)
- Output Discharge Circuit (MIC5397, MIC5399)
- · Thermal Shutdown Protection
- · Current Limit Protection
- 8-Pin 1.6 mm × 1.2 mm Extra Thin DFN Package

Applications

- Smartphones
- · DSC, GPS, PMP and PDAs
- · Medical Devices
- · Portable Electronics

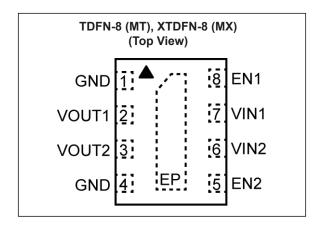
General Description

The MIC5396/7/8/9 is an advanced dual LDO ideal for powering general purpose portable devices. The MIC5396/7/8/9 provides two high performance, independent 300 mA LDOs in a single package. This makes it possible to improve system efficiency by providing two independent supply inputs that can be optimized for each individual LDO. The MIC5396/7/8/9 also features a wide output voltage range down to 1.0V.

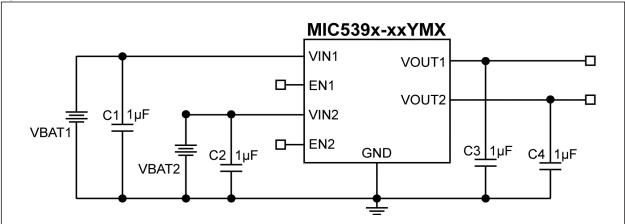
Its full feature set and low dropout voltage make it ideal for battery-powered applications. The MIC5396/7/8/9 offers 2% accuracy, low dropout voltage (160 mV at 300 mA), and low ground current (typically 42 μ A per LDO at full load). The MIC5396/7/8/9 can also be put into a zero off mode current state, drawing virtually no current when disabled.

When the MIC5397/9 is disabled, an internal resistive load is automatically applied to the output to discharge the output capacitor. In addition, the MIC5398/9 offers an internal enable pull-down resistor to ensure that the output is disabled when the enable is in tri-state mode. These LDO's also offer fast transient response and high PSRR while consuming a minimum operating current. The family is available in a tiny 8-Pin, 1.6 mm x 1.2 mm leadless Extra Thin DFN package.

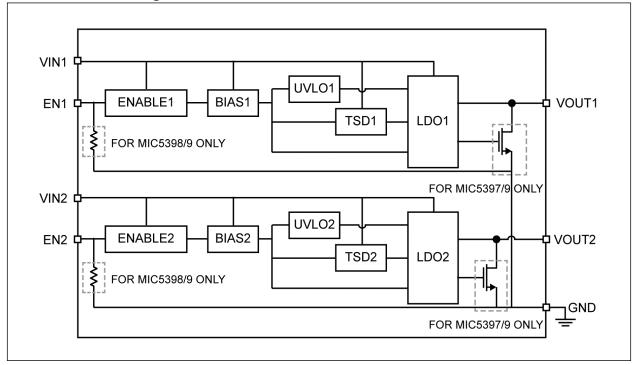
Package Type



Typical Application Schematic



Functional Block Diagram



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

Supply Voltage (V _{IN1} , V _{IN2})	0.3V to +6V
Enable Voltage (V _{EN1} , V _{EN2})	
Power Dissipation (P _D) Note 1	***
Lead Temperature (Soldering, 10sec.)	
Junction Temperature (T _J)	
Storage Temperature (T _S)	
ESD Rating Note 2	3 kV
Operating Ratings ‡	
Supply Voltage (V _{IN1} , V _{IN2})	+2.5V to +5.5V
Enable Voltage (V _{EN1} , V _{EN2})	
Junction Temperature (T ₁)	
Package Thermal Resistance	

† Notice: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

- **‡ Notice:** The device is not guaranteed to function outside its operating ratings.
 - Note 1: The maximum allowable power dissipation of any T_A (ambient temperature) is $P_{D(max)} = (T_{J(max)} T_A) / \theta_{JA}$. Exceeding the maximum allowable power dissipation will result in excessive die temperature, and the regulator will go into thermal shutdown.
 - 2: Devices are ESD sensitive. Handling precautions are recommended. Human body model, 1.5 k Ω in series with 100 pF.

ELECTRICAL CHARACTERISTICS

Electrical Characteristics: $V_{IN1} = V_{EN1} = V_{OUT1} + 1V$, $V_{IN2} = V_{EN2} = V_{OUT2} + 1V$, $I_{OUT1} = I_{OUT2} = 100 \mu A$; $C_{IN1} = C_{IN2} = C_{OUT1} = C_{OUT2} = 1 \mu F$; $T_A = +25^{\circ}C$. **Bold** values are valid for $-40^{\circ}C$ to $+125^{\circ}C$, unless noted. **(Note 1)**.

Parameters	Symbol	Min.	Тур.	Max.	Units	Conditions	
Output Voltage Accuracy	V _{OUT}	-2.0 - 3.0		+2.0 +3.0	%	Variation from nominal V _{OUT}	
Line Regulation	_	1	0.02	0.3	%/V	$V_{IN} = V_{OUT} + 1V \text{ to } 5.5V,$ $I_{OUT} = 100 \ \mu\text{A}$	
Load Regulation	_	_	8	40	mV	I _{OUT} = 100 μA to 300 mA	
Dropout Voltage	\/	_	80	190	mV	I _{OUT} = 150 mA	
	V _{DO}		160	380	111 V	I _{OUT} = 300 mA	
		_	37	55		V_{EN1} = High; V_{EN2} = Low; I_{OUT2} = 0 mA	
		_	37	55		V _{EN1} = Low; V _{EN2} = High; I _{OUT1} = 0 mA	
Ground Pin Current		_	74	110	μA	$V_{EN1} = V_{EN2} = High;$ $I_{OUT1} = I_{OUT2} = 0 mA$	
Glound Fill Culterit	I _{GND}	_	42	65	μA	V_{EN1} = High; V_{EN2} = Low; I_{OUT1} = 300 mA	
		-	42	65		V _{EN1} = Low; V _{EN2} = High; I _{OUT2} = 300 mA	
		-	84	130		$V_{EN1} = V_{EN2} = High;$ $I_{OUT1} = I_{OUT2} = 300 \text{ mA}$	
Shutdown Current	I _{SHDN}		0.05	1	μA	$V_{EN1} = V_{EN2} = 0V$	
Ripple Rejection	PSRR		60	1	dB	f = 1 kHz; C _{OUT} = 1 μF	
Current Limit	I _{LIM}	400	630	900	mA	V _{OUT} = 0V	
Output Voltage Noise	e _N		93	1	μV _{RMS}	$C_{OUT} = 1\mu F$, 10 Hz to 100 kHz	
Auto-Discharge NFET Resistance	R _{DS(ON)}		25		Ω	MIC5397, MIC5399 Only; $V_{EN1} = V_{EN2} = 0V; V_{IN} = 3.6V;$ $I_{OUT} = -3 \text{ mA}$	
Enable Inputs (EN1/EN2)							
Enable Pull-Down Resistor	R _{PULL-DN}	_	4		ΜΩ	MIC5398, MIC5399	
Enable Input Voltage	V _{EN-LOW}	_	_	0.2		Logic Low	
Enable Input Voltage	V _{EN-HIGH}	1.2	_	_	V	Logic High	
Enable Input Current	I _{EN}		0.01	1	μΑ	V _{EN} = 0V	
MIC5396, MIC5397		_	0.01	1		V _{EN} = 5.5V	
Enable Input Current		_	0.01	1	μA	V _{EN} = 0V	
MIC5398, MIC5399	I _{EN}		1.4	2	μA	V _{EN} = 5.5V	
Turn-On Time	t _{ON}	_	50	125	μs	C _{OUT} = 1 μF	

Note 1: Specification for packaged product only.

TEMPERATURE SPECIFICATIONS

Parameters	Symbol	Min.	Тур.	Max.	Units	Conditions
Temperature Ranges						
Junction Temperature Range	T _J	-40	_	+125	°C	Note 1
Storage Temperature Range	T _S	-65	_	+150	°C	_
Lead Temperature	_	_	_	260	°C	Soldering, 10 sec.
Package Thermal Resistances						
Thermal Resistance, DFN-8	0		172.6		°C/W	
Thermal Resistance, Extra Thin DFN-8	θ_{JA}	_	172.0	_	C/VV	_

Note 1: The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e., T_A , T_J , θ_{JA}). Exceeding the maximum allowable power dissipation will cause the device operating junction temperature to exceed the maximum +125°C rating. Sustained junction temperatures above +125°C can impact the device reliability.

2.0 TYPICAL PERFORMANCE CURVES

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

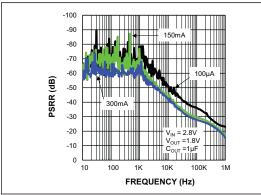


FIGURE 2-1: Ratio.

Power Supply Rejection

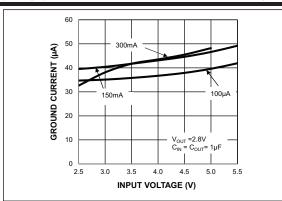


FIGURE 2-4: Voltage.

Ground Current vs. Input

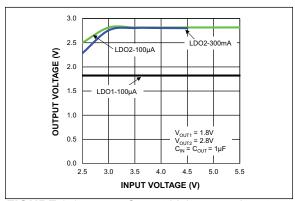
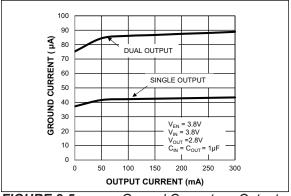


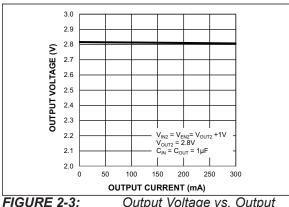
FIGURE 2-2: Voltage.

Output Voltage vs. Input



Current.

FIGURE 2-5: Ground Current vs. Output



Current.

Output Voltage vs. Output

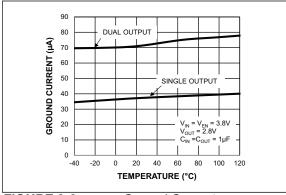


FIGURE 2-6: Temperature.

Ground Current vs.

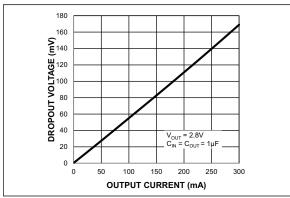


FIGURE 2-7: Current.

Dropout Voltage vs. Output

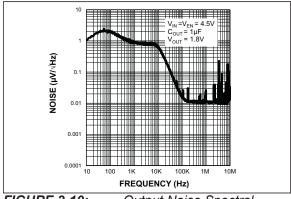


FIGURE 2-10: Density.

Output Noise Spectral

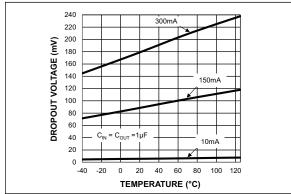


FIGURE 2-8:

Dropout Voltage vs.



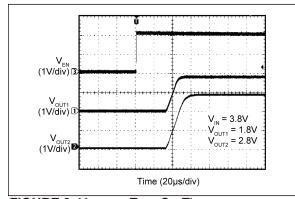


FIGURE 2-11:

Turn-On Time.

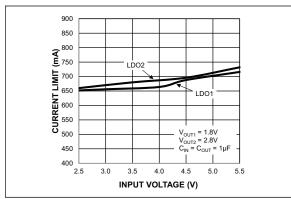


FIGURE 2-9:

Current Limit vs. Input

Voltage.

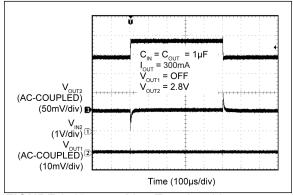
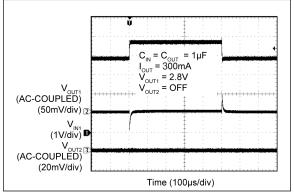
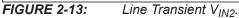


FIGURE 2-12:

Line Transient V_{IN1}.





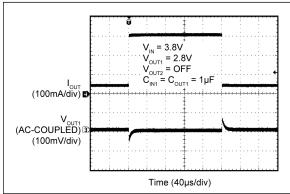


FIGURE 2-14: Load Transient V_{OUT1}.

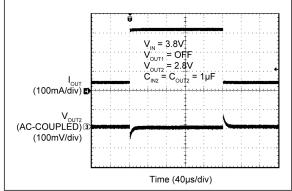


FIGURE 2-15: Load Transient V_{OUT2}.

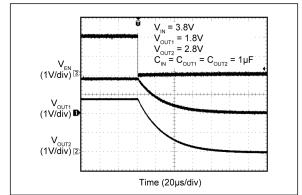


FIGURE 2-16: Turn-Off Time.

3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 3-1.

TABLE 3-1: PIN FUNCTION TABLE

Pin Number	Pin Name	Description
1, 4	GND	Ground.
2	VOUT1	Output regulator 1. Connect a capacitor to ground.
3	VOUT2	Output regulator 2. Connect a capacitor to ground.
5	EN2	Enable input for regulator 2: Active-high input. Logic high = On; Logic low = Off. MIC5396/7 Do not leave floating. MIC5398/9 internal pull-down resistor, tri-state = Off.
6	VIN2	Input voltage supply for regulator 2. Connect a capacitor to ground.
7	VIN1	Input voltage supply for regulator 1. Connect a capacitor to ground.
8	EN1	Enable input for regulator 1: Active-high input. Logic high = On; Logic low = Off. MIC5396/7 Do not leave floating. MIC5398/9 internal pull-down resistor, tri-state = Off.
EP	ePad	Exposed heat sink pad. Connect to ground.

4.0 APPLICATION INFORMATION

MIC5396/7/8/9 is a dual 300 mA LDO in a tiny 8-pin 1.2 mm x 1.6 mm extra thin DFN package. The MIC5397 and MIC5399 include an auto-discharge circuit for each LDO output, which is activated when the output is disabled. The MIC5398 and MIC5399 have an internal pull-down resistor on the enable pin to ensure that the output is disabled if the control signal is tri-stated. The MIC5396/7/8/9 regulator is fully protected from damage due to fault conditions using linear current limiting and thermal shutdown. These devices are not suitable for RF transmitter systems.

4.1 Input Capacitor

The MIC5396/7/8/9 is high-performance, а high-bandwidth device. An input capacitor of 1 µF capacitor is required from the input to ground to provide stability. Low-ESR ceramic capacitors provide optimal performance at a minimum of space. Additional high-frequency capacitors, such as small valued NPO dielectric type capacitors, help filter out high-frequency noise and are good practice in any RF-based circuit. X5R or X7R dielectrics are recommended for the input capacitor. Y5V dielectrics lose most of their capacitance over temperature and are therefore, not recommended.

4.2 Output Capacitor

The MIC5396/7/8/9 requires an output capacitor of $1\,\mu\text{F}$ or greater to maintain stability. The design is optimized for use with low-ESR ceramic chip capacitors. High-ESR capacitors may cause high frequency oscillation. The output capacitor can be increased, but performance has been optimized for a $1\,\mu\text{F}$ ceramic output capacitor and does not improve significantly with larger capacitance.

X7R/X5R dielectric-type ceramic capacitors are recommended because of their temperature performance. X7R type capacitors change capacitance by 15% over their operating temperature range and are the most stable type of ceramic capacitors. Z5U and Y5V dielectric capacitors change value by as much as 50% and 60%, respectively, over their operating temperature ranges. To use a ceramic chip capacitor with Y5V dielectric, the value must be much higher than an X7R ceramic capacitor to ensure the same minimum capacitance over the equivalent operating temperature range.

4.3 No-Load Stability

Unlike many other voltage regulators, the MIC5396/7/8/9 will remain stable and in regulation with no load.

4.4 Enable/Shutdown

The MIC5396/7/8/9 comes with two active-high enable pins that allow each regulator to be disabled independently. Forcing the enable pin low disables the regulator and sends it into an off mode current state drawing virtually zero current. When disabled, the MIC5397 and MIC5399 switch an internal 25Ω load on the regulator output to discharge the external capacitor.

Forcing the enable pin high enables the output voltage. The MIC5396 and MIC5397 active-high enable pin uses CMOS technology and cannot be left floating. A floating enable pin may cause an indeterminate state on the output. The MIC5398 and MIC5399 have an internal pull-down resistor on the enable pin to disable the output when the enable pin is floating.

4.5 Thermal Considerations

The MIC5396/7/8/9 is designed to provide two 300 mA continuous current outputs in a very small package. Maximum operating temperature can be calculated based on the output currents and the voltage drop across the part. For example, if the input voltage is 3.6V, V_{OUT1} = 3.3V, V_{OUT2} = 2.8V, each with an output current of 300 mA. The actual power dissipation of the regulator circuit can be determined using Equation 4-1:

EQUATION 4-1:

$$\begin{split} P_D &= (V_{IN} - V_{OUT1})I_{OUT1} + \\ (V_{IN} - V_{OUT2})I_{OUT2} + V_{IN} \times I_{GND} \end{split}$$

Because this device is CMOS and the ground current is typically <100 μ A over the load range, the power dissipation contributed by the ground current is <1% and can be ignored for the calculation in Equation 4-2:

EQUATION 4-2:

$$\begin{split} P_D &= (3.6V - 3.3V)300mA + \\ (3.6V - 2.8V)300mA \\ P_D &= 0.33W \end{split}$$

To determine the maximum ambient operating temperature of the package, use the junction-to-ambient thermal resistance of the device and the following basic formula in Equation 4-3:

EQUATION 4-3:

$$P_{D(MAX)} = \left(\frac{T_{J(MAX)} - T_A}{\theta_{JA}}\right)$$

Where:

$$T_{J(MAX)} = 125^{\circ}C$$

 $\theta_{JA} = 172.6^{\circ}C/W$

Substituting P_D for $P_{D(max)}$ and solving for the ambient operating temperature will give the maximum operating conditions for the regulator circuit. The junction-to-ambient thermal resistance for the minimum footprint is 172.6°C/W.

The maximum power dissipation must not be exceeded for proper operation.

For example, when operating a 3.3V/2.8V application with an input voltage of 3.6V and 300 mA at each output with a minimum footprint layout, the maximum ambient operating temperature T_A can be determined as follows:

EQUATION 4-4:

$$0.33W = (125^{\circ}C - TA)/(172.6^{\circ}C/W)$$
$$T_A = 68.04^{\circ}C$$

Therefore, a MIC5396-SMYMX application with 300 mA at each output current can accept an ambient operating temperature of 68.04°C in a 1.6 mm x 1.2 mm Extra Thin DFN package. For a full discussion of heat sinking and thermal effects of voltage regulators, refer to the "Regulator Thermals" section of Designing with Low-Dropout Voltage Regulators handbook.

5.0 TYPICAL APPLICATION SCHEMATIC

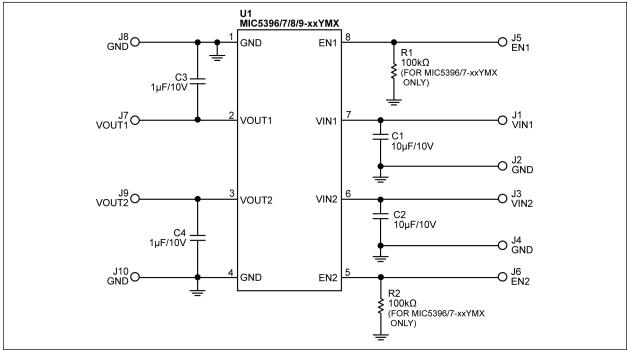


FIGURE 5-1: MIC5396/7/8/9-x.xYMX Typical Application Schematic.

TABLE 5-1: BILL OF MATERIALS

Item	Part Number	Manufacturer	Description	Qty.
C1, C2	C1608X5R0J106K	TDK	Capacitor, 1 µF Ceramic, 10V, X5R, Size 0402	2
C1, C2	C1005X5R1A105K	TDK	Capacitor, 1 µF Ceramic, 10V, X5R, Size 0402	2
C1, C2	CR0603100KFKEA	Vishay	Resistor, 100 kΩ, 1/16W, Size 0603	2
U1	MIC5396/7/8/9-xxYMX	Microchip	Dual, 300 mA LDO, Size 1.2mm × 1.6mm Extra Thin DFN	1

6.0 PCB LAYOUT RECOMMENDATIONS

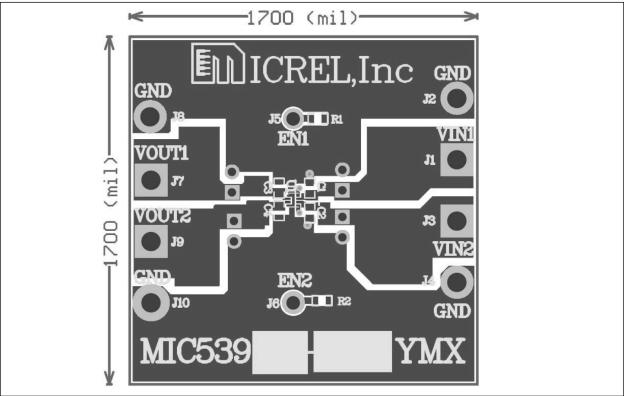


FIGURE 6-1: Top Layer.

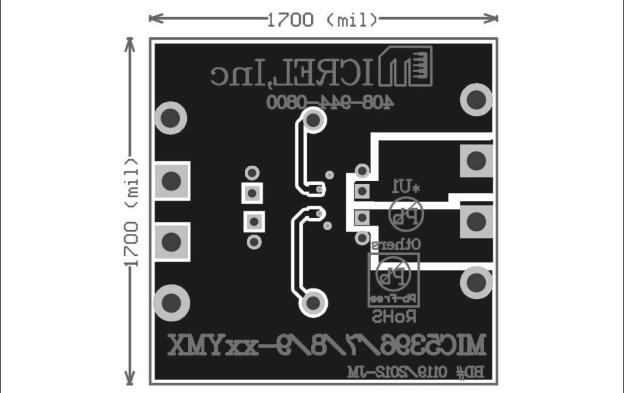
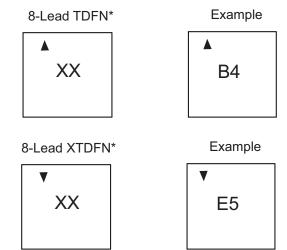


FIGURE 6-2: Bottom Layer.

7.0 PACKAGING INFORMATION

7.1 Package Marking Information



Legend: XX...X
Year code (last digit of calendar year)
YY Year code (last 2 digits of calendar year)
WW Week code (week of January 1 is week '01')
Alphanumeric traceability code
Pb-free JEDEC® designator for Matte Tin (Sn)
* This package is Pb-free. The Pb-free JEDEC designator (and be found on the outer packaging for this package.

•, ♠, ▼ Pin one index is identified by a dot, delta up, or delta down (triangle mark).

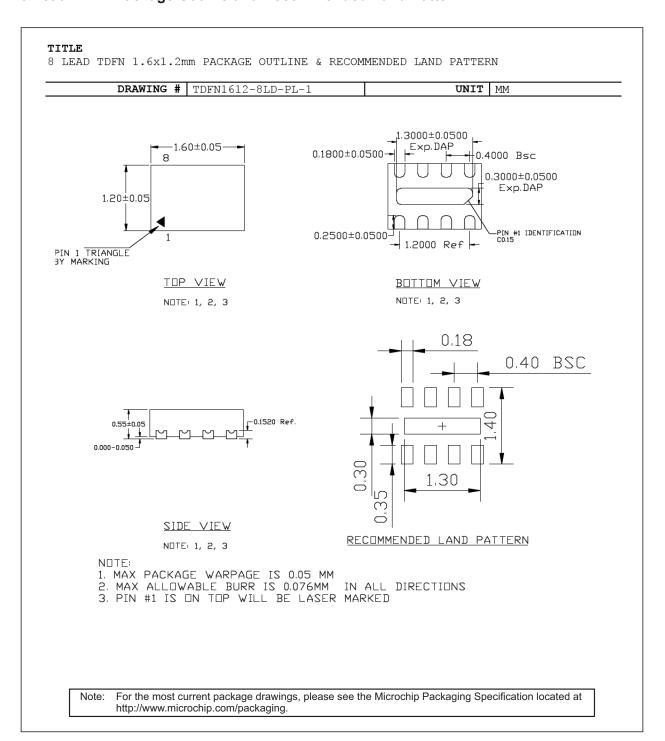
lote: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information. Package may or may not include the corporate logo.

Underbar (_) symbol may not be to scale.

TABLE 7-1: PACKAGE MARKING CODES FOR MIC5396/97/98/99

Part Number	Output Voltage	Marking Codes		
MIC5396-GMYMX	1.8V/2.8V	F2		
MIC5397-GPYMX	1.8V/3.0V	D4		
MIC5398-P4YMX	3.0V/1.2V	E5		
MIC5399-SSYMX	3.3V/3.3V	H4		
MIC5399-SMYMX	3.3V/2.8V	H6		
MIC5399-SGYMX	3.3V/1.8V	H5		
MIC5399-MMYMX	2.8V/2.8V	H7		
MIC5399-GMYMX	1.8V/2.8V	H1		

8-Lead TDFN Package Outline and Recommended Land Pattern



8-Lead XTDFN Package Outline and Recommended Land Pattern

TITLE 8 LEAD XTDFN 1.6x1.2mm PACKAGE OUTLINE & RECOMMENDED LAND PATTERN DRAWING # XTDFN1612-8LD-PL-1 UNIT MM Lead Frame NiPdAu Lead Finish NiPdAu 1.3000±0.050 Exp.DAP 1.6000±0.050 5 0.050 2.00±0.050 1.2000±0.050 PIN #1 IDENTIFICATION CHAMFER 0.150 X 45* 0.1800±0.050 PIN 1 TRIANGLE BY MARKING TOP VIEW BOTTOM VIEW N□TE: 1, 2 N□TE: 1, 2, 3 0.18 0.40 BSC 0.400 MAX 0.1270 Ref. 0.000-0.0500 SIDE VIEW NDTE: 1, 2 RECOMMENDED LAND PATTERN NDTE: 1. MAX PACKAGE WARPAGE IS 0.05 MM 2. MAX ALLOWABLE BURR IS 0.076MM IN ALL DIRECTIONS 3. LEAD AND EPAD CORNER MAXIMUM RADIUS 0.075MM

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging.

NOTES:

APPENDIX A: REVISION HISTORY

Revision A (October 2019)

- Converted Micrel document MIC5396/7/8/9 to Microchip data sheet DS20006264A.
- · Minor text changes throughout.
- Added Symbols column in the Section "Electrical Characteristics" table.
- Updated Section 4.0, Application Information with adding this new sentence - These devices are not suitable for RF transmitter systems.
- Changed I_{OUT} = 300 mA from 500 mA in Figure 2-12 and Figure 2-13.

Revision B (January 2020)

 Updates to the Product Information System in the Examples table and in the voltage option segment.

NOTES:

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

PART NO.	- <u>XX</u>	X T	<u>xx</u>	<u>-X</u>	<u>X</u>	Examples	:	
Device:	Voltage Option	Junction Temperature Range	Package	Media	Туре	a) MIC5396	6-GMYMT-T5	Low-Power Dual 300 mA LDO, 1.8V/2.8V, -40°C to +125°C, 8- Lead 1.6 mm x 1.2 mm TDFN, 500/ Reel
	MIC53	97: Low-Power Dual 300 r charge Circuit 98: Low-Power Dual 300 r Pull-Down 99: Low-Power Dual 300 r	mA LDO with	· Internal Er	nable	b) MIC5396	6-GMYMX-TR	Low-Power Dual 300 mA LDO, 1.8V/2.8V, -40°C to +125°C, 8- Lead 1.6 mm x 1.2 mm XTDFN, 5,000/Reel
Voltage Option	GM = 1	charge Circuit and Inte 1.8V/2.8V (MIC5396)				c) MIC5397	7-GPYMT-T5	Low-Power Dual 300 mA LDO with Output Discharge Circuit, 2.8V/ 1.5V, -40°C to +125°C, 8-Lead 1.6 mm x 1.2 mm TDFN, 500/Reel
	P4 = 3 SS = 1 SM = 3 SG = 3	2.8V/1.5V (MIC5397) .0V/1.2V (MIC5398) .8V/3.0V (MIC5399) 3.3V/3.3V (MIC5399) 3.3V/1.8V (MIC5399) 3.3V/2.8V (MIC5399)				d) MIC5397	7-GPYMX-TR	Low-Power Dual 300 mA LDO with Output Discharge Circuit, 2.8V/ 1.5V, -40°C to +125°C, 8-Lead 1.6 mm x 1.2 mm XTDFN, 5,000/ Reel
Junction Temperature		2.8/V2.8V (MIC5399)	HS Complian	t)		e) MIC5398	8-P4YMX-T5	Low-Power Dual 300 mA LDO with Internal Enable Pull-Down, 3.0V/ 1.2V, -40°C to +125°C, 8-Lead 1.6 mm x 1.2 mm XTDFN, 500/Reel
Range:	MT = MX =					f) MIC5398	3-P4YMX-TR	Low-Power Dual 300 mA LDO with Internal Enable Pull-Down, 3.0V/ 1.2V, -40°C to +125°C, 8-Lead 1.6 mm x 1.2 mm XTDFN, 5,000/Reel
Media Type:	T5 TR	= 500/Reel = 5,000/Reel				e) MIC5399	9-GMYMT-T5	Low-Power Dual 300 mA LDO with Output Discharge Circuit and Internal Enable Pull-Down, 1.8V/ 3.0V, -40°C to +125°C, 8-Lead 1.6 mm x 1.2 mm TDFN, 500/Reel
						e) MIC5399	9-SGYMX-TR	Low-Power Dual 300 mA LDO with Output Discharge Circuit and Internal Enable Pull-Down, 3.3V/ 1.8V, -40°C to +125°C, 8-Lead 1.6 mm x 1.2 mm XTDFN, 5,000/Reel
						g) MIC5399	9-SSYMX-TR	Low-Power Dual 300 mA LDO with Output Discharge Circuit and Internal Enable Pull-Down, 3.3V/ 3.3V, -40°C to +125°C, 8-Lead 1.6 mm x 1.2 mm XTDFN, 5,000/Reel
						Note 1: Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option.		

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